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## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT	
NATURE OF CONVEYANCE:	Corrective Assignment to correct the Assignee's Address to 6-32, Nakanoshima 3-chome, Kita-ku, Osaka-shi, Osaka, 530-0005, Japan previously recorded on Reel 020857 Frame 0574. Assignor(s) hereby confirms the Assignment.	

### **CONVEYING PARTY DATA**

Name	Execution Date	
Katsuyoshi HOSHINO	03/20/2008	

### **RECEIVING PARTY DATA**

Name:	CHISSO CORPORATION	
Street Address:	6-32, Nakanoshima 3-chome, Kita-ku, Osaka-shi	
City:	Osaka	
State/Country:	JAPAN	
Postal Code:	530-0005	

## PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	10526147	

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	052095	
NAME OF SUBMITTER:	Lee C. Wright	

Total Attachments: 1

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PATENT REEL: 021120 FRAME: 0993

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Westerman,	Hattori,	Daniels &	& Adrian,	LLP
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Docket No.\_\_\_\_

**RECORDED: 06/19/2008** 

### ASSIGNMENT

WHEREAS, Katsuyoshi HOSHINO, having residence at 16-2, Matsunami 4-chome, Chuo-ku, Chiba-shi, Chiba 260-0044, Japan, is the assignee of entire right, title and interest in and to any and all improvements in "MODIFIED ELECTROCONDUCTIVE POLYMER MATERIAL AND PRODUCTION METHOD THEREFOR" as described and claimed in United States Patent Application Serial No.10/526,147, filed October 21,2005, by assignment attached hereto.

WHEREAS, **Katsuyoshi HOSHINO**, hereinafter ASSIGNOR in this Assignment, wishes to assign and transfer to **CHISSO CORPORATION**, having an office and place of business at 6-32,Nakanoshima 3-chome,Kita-ku,Osaka-shi,Osaka,530-0005,Japan hereinafter ASSIGNEE in this Assignment, and said ASSIGNEE wishes to acquire the entire right, title and interest in, to and under said improvements and said United States Patent Application and any and all U.S. patents granted therein.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt whereof is hereby acknowledged, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to said improvements and said United States patents granted therefor and any continuation, divisional, renewal substitute or reissue thereof for the full term or terms for which the same may be granted.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment and sale;

ASSIGNOR further covenants that it will, upon request by the ASSIGNEE promptly provide all pertinent facts and documents relating to said invention and said United States Patents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said improvements and said United States patents which may be necessary or desirable to carry out the purposes hereof.

IN WITNESS WHEREOF, have hereunto set hand and seal this 2004h day of March, 2008.

Assignor: Katsuyoshi HOSHINO

By: Katsuyoshi Hoshino

PATENT REEL: 021120 FRAME: 0994